

INFORMATION CITED BY APPLICANTS THAT MAY BE MATERIAL TO THE  
PROSECUTION OF THE SUBJECT APPLICATION

Applicants: Jee-Soo Mok, Jang-Kyu Kang, and Attorney Docket No. LEPA121687  
Chang-Hyun Nam

Title: METHOD OF FORMING SOLDER RESIST PATTERN

U.S. PATENT DOCUMENT

| *Examiner<br>Initials | Cite<br>No. | Document No. | Kind<br>Code | Date<br>(mm/dd/yyyy) | Name   |
|-----------------------|-------------|--------------|--------------|----------------------|--------|
| <u>SA</u>             | U1          | 5,324,535    |              | 06/28/1994           | Ishido |

FOREIGN PATENT DOCUMENTS

| *Examiner<br>Initial | Cite<br>No. | Document No. | Kind<br>Code | Publication Date<br>(mm/dd/yyyy) | Country | English<br>Abstract<br>Provided | Translation<br>Provided |
|----------------------|-------------|--------------|--------------|----------------------------------|---------|---------------------------------|-------------------------|
| None                 |             |              |              |                                  |         |                                 |                         |

OTHER INFORMATION

(Including Author, Title, Date, Pertinent Pages, Etc.)

| *Examiner<br>Initial | Cite<br>No. |
|----------------------|-------------|
| None                 |             |

Examiner

Shamim Ahmed

Date Considered

5/17/05

\*Examiner: Initial if reference considered, whether or not citation is in conformance with M.P.E.P. § 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicants.

JEN:hjd